

**Amendments to the Claims:**

This listing of claims will replace all prior versions and listings of claims in the application:

**Listing of Claims:**

- 5           1. (Original) An apparatus for testing ball grid arrays ("BGAs") comprising:  
a socket slot in a printed circuit board for holding a socket used for testing the BGAs; and  
plural holding members that support BGA solder balls.
2. (Original) The apparatus of Claim 1, wherein the socket top may have plural prong  
like holding members for supporting the solder balls.
- 10           3. (Cancelled)
4. (Cancelled)
5. The apparatus of Claim 1, wherein the holding members may be etched on a BGA  
socket top.
6. (Original) The apparatus of Claim 1, wherein the holding members are flexible, rigid  
15           and/or semi-rigid to provide support for the solder balls.